

SHARP CORPORATION

## SHARP

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

#### **SPECIFICATION**

DEVICE SPECIFICATION FOR

	MODEL No.	VOLTAGE R	EGULATOR		
•		PQ**R	D1BJ00H		
		-			
		Applie	d model name	en de la companya de La companya de la co	•
		PQ	05RD1BJ00H 09RD1BJ00H		
		PQ	12RD1BJ00H		
Specified for	•				
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•					7
After	osed please find copies of the confirmation of the conter approving signature on eac	its, please be sure	which consists of to send back	of 13 pages including of copies of the Speci	cover. fications
		•			•
CUS	TOMER'S APPROVAL			PRESENTED	•
DAT	E			DATE	
ВУ				BY /V, 9	7
				H.Imanaka, Department Gen Engineering Dep	t.,II
				Opto-Electronic ELECOM Grou	Devices Div.

Product name: VOLTAGE REGULATOR

Model No.: PQ\*\*RD1BJ00H

Applied Model No.: PQ05RD1BJ00H, PQ09RD1BJ00H, PQ12RD1BJ00H

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- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

#### (Precautions)

- (1) This product is designed for use in the following application areas;
  - OA equipment
     Audio visual equipment
     Home appliances
  - Telecommunication equipment (Terminal) Measuring equipment
  - Tooling machines Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
  - Transportation control and safety equipment (aircraft, train, automobile etc.)
  - Traffic signals Gas leakage sensor breakers Rescue and security equipment
  - Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
  - Space equipment 
     • Telecommunication equipment (for trunk lines)
  - Nuclear power control equipment Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.



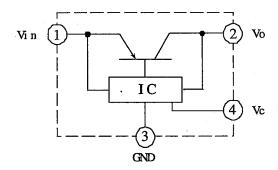
#### 1. Application

This specification applies to the outline and characteristics of low power dissipation regulator (linear type), Model No. PQ\*\*RD1BJ00H.

#### Usage

PQ\*\*RD1BJ00H are the devices for stabilization of positive DC output voltage with built-in ON/OFF function, the over current protection function, the overheat protection function and the ASO protection function. These devices are possible to be used in power supply circuit up to current capacity 1A.

Block diagram



- 2. Outline: Refer to the attached sheet, Page 3.
  - 3. Ratings and characteristics: Refer to the attached sheet, page 4 to 7.
    - 3.1 Absolute maximum ratings
    - 3.2 Electrical characteristics
    - 3.3 Electrical characteristics measuring circuit
  - 4. Reliability: Refer to the attached sheet, Page 8.
  - 5. Outgoing inspection: Refer to the attached sheet, Page 9.
  - 6. Supplement: Refer to the attached sheet, Page 9, 10.
    - 6.1 Example of application
    - 6.2 Over current protection characteristics (Typical value)
    - 6.3 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride,

1.1.1-Trichloroethane (Methylchloroform)

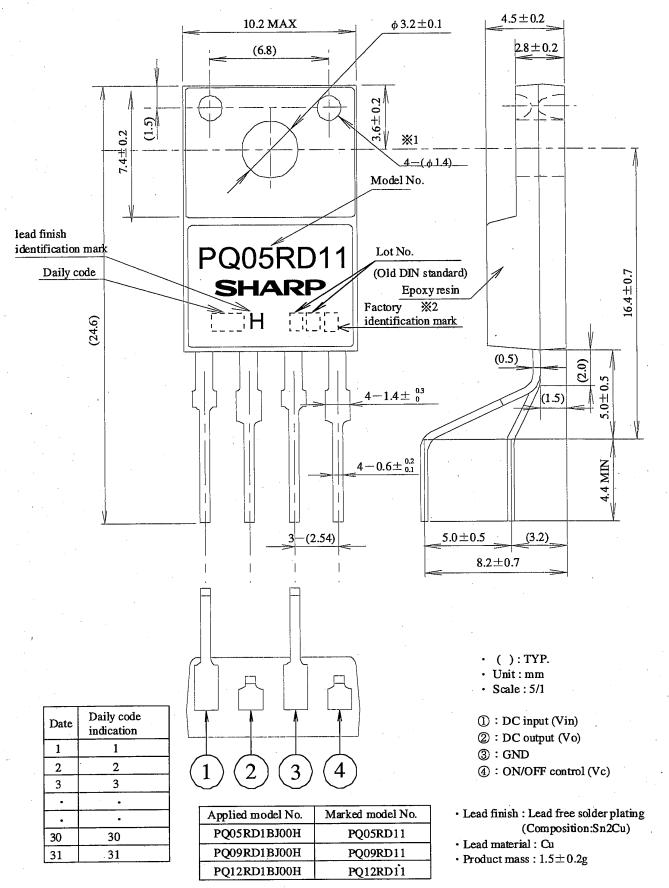
#### 6.4 Brominated flame retardants

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.

- 6.5 This product is not designed as electromagnetic and ionized-particle radiation resistant.
- 7. Notes: Refer to the attached sheet, Page 11, 12.
  - 7.1 External connection
  - 7.2 Mounting
  - 7.3 Thermal protection design
  - 7.4 Static electricity
  - 7.5 For cleaning
  - 7.6 Storage environment

# D-040060 POT RELIBIOOH hily 18, 2004

#### 2. Outline



※1 The holes are both the surface and the under surface.

**※2** ▲: P.T.SHARP SEMICONDUCTOR INDONESIA

Without: Fujimoto Electric. Co., Ltd.



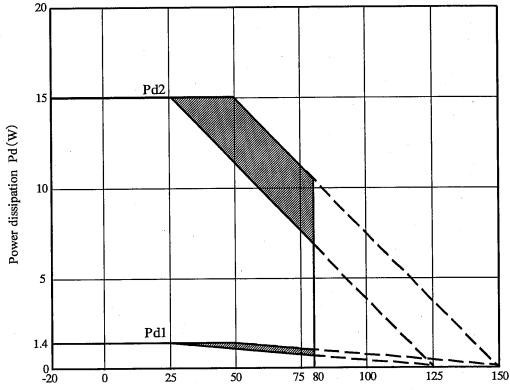
- 3. Ratings and characteristics
- 3.1 Absolute maximum ratings

Ta=25℃

Parameter	Symbol	Rating	Unit	Conditions
Input voltage (*1)	Vin	20	v	
ON/OFF control terminal voltage (*1)	Vc	20	V	
Output current	Io	1.0	Α	
Powerdissipation (*2)	Pd1	1.4	w	Refer to Fig. 1
	Pd2	15	w	
Junction temperature (*3)	Tj	150	°C	
Operating temperature	Topr	-20 to +80	လ	
Storage temperature	Tstg	-40 to +150	°C	
Soldering temperature	Tsol	260	c	For 10 s

- (\*1) All are open except GND and applicable terminals.
- (\*2) Pd1: No heat sink, Pd2: With infinite heat sink
- (\*3) There is case that over heat protection function operates at the temperature Tj=125 to  $150^{\circ}$ C, this item cannot be used in this temperature range.

Fig. 1 Pd - Ta rating



Ambient temperature Ta(℃)

Pd 1: No heat sink

Pd 2: With infinite heat sink

(Note) There is case that over heat protection function operates at oblique line portion.



#### 3.2 Electrical characteristics

#### (1) PQ05RD1BJ00H

Unless otherwise specified condition shall be Vin=7V, Io=0.5A

Ta=25℃

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Conditions
Output voltage	Vo	4.85	5	5.15	V	
Load regulation	RegL	-	0.1	2.0	%	Io=5mA to 1A
Line regulation	RegI	-	0.5	2.5	%	Vin=6 to 12V Io=5mA
Temperature coefficient of output voltage	TcVo	-	±0.02	-	%/℃	Tj=0 to 125°C Io=5mA
Ripple rejection	RR	45	55	-	dВ	Refer to Fig.3
Dropout voltage	Vi-o	-	-	0.5	V	(*4) Io=0.5A
On-state voltage for control (*5)	Vc (on)	2.0	-	-	V	
On-state current for control	Ic (on)	-	-	20	μΑ	Vc=2.7V
Off-state voltage for control	Vc (off)	-	-	0.8	V	
Off-state current for control	Ic (off)	-	-	-0.4	mA	Vc=0.4V
Quiescent current	Iq	-	-	- 10	mA	Io=0A

- (\*4) Input voltage shall be the value when output voltage is 95% in comparison with the initial value.
- (\*5) In case of opening control terminal (4th pin), output voltage turns ON.

#### (2) PQ09RD1BJ00H

Unless otherwise specified condition shall be Vin=11V, Io=0.5A

Ta=25°C

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Conditions
Output voltage	Vo	8.73	9.0	9.27	V	
Load regulation	RegL	•	0.1	2.0	%	Io=5mA to 1A
Line regulation	RegI	-	0.5	2.5	%	Vin=10 to 16V
Temperature coefficient of output voltage	TcVo	-	±0.02	-	%/°C	Tj=0 to 125°C Io=5mA
Ripple rejection	RR	45	55	-	dB	Refer to Fig.3
Dropout voltage	Vi-o		_	0.5	V	(*4) Io=0.5A
On-state voltage for control (*5)	Vc (on)	2.0	-	-	V	
On-state current for control	Ic (on)	-	-	20	μΑ	Vc=2.7V
Off-state voltage for control	Vc (off)	-	-	0.8	V	
Off-state current for control	Ic (off)	-	-	-0.4	mA	Vc=0.4V
Quiescent current	Iq	-	-	10	mA	Io=0A

- (\*4) Input voltage shall be the value when output voltage is 95% in comparison with the initial value.
- (\*5) In case of opening control terminal (4th pin), output voltage turns ON.



#### (3) PQ12RD1BJ00H

Unless otherwise specified condition shall be Vin=14V, Io=0.5A

Ta=25℃

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Conditions
Output voltage	Vo	11.64	12.0	12.36	V	
Load regulation	RegL	-	0.1	2.0	%	Io=5mA to 1A
Line regulation	RegI	-	0.5	2.5	%	Vin=13 to 19V
Temperature coefficient of output voltage	TcVo	_	±0.02	-	%/°C	Tj=0 to 125°C Io=5mA
Ripple rejection	RR	45	55	-	dB	Refer to Fig.3
Dropout voltage	Vi-o	-	-	0.5	V	(*4) Io=0.5A
On-state voltage for control (*5)	Vc (on)	2.0	-	-	V	
On-state current for control	Ic (on)	-	_	20	μΑ	Vc=2.7V
Off-state voltage for control	Vc (off)	-	-	0.8	V	
Off-state current for control	Ic (off)	-	-	-0.4	mA	Vc=0.4V
Quiescent current	Iq	-	-	10	mA	Io=0A

<sup>(\*4)</sup> Input voltage shall be the value when output voltage is 95% in comparison with the initial value.

<sup>(\*5)</sup> In case of opening control terminal (4th pin), output voltage turns ON.



#### 3.3 Electrical characteristics measuring circuit

### Fig. 2 Standard measuring circuit of Regulator portion

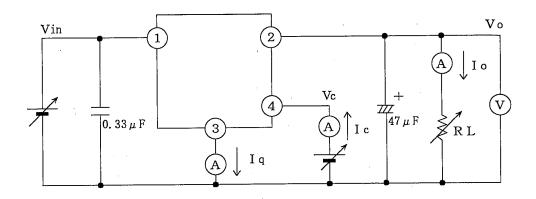


Fig. 3 Standard measuring circuit of critical rate of ripple rejection

f=120Hz sine wave

ei(rms)=0.5V

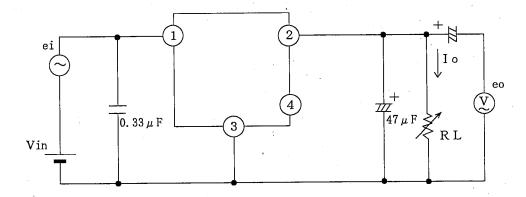
Vin=7V (PQ05RD1BJ00H)

=11V (PQ09RD1BJ00H)

=14V (PQ12RD1BJ00H)

Io=0.5A

RR=201og (ei(rms)/eo(rms))





#### 4. Reliability

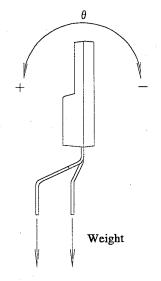
The reliability of products shall satisfy items listed below.

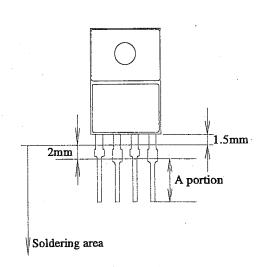
Confidence level: 90%

LTPD: 10 or 20

	m . G . V.:	T-11 - I-d Citai	Samples (n)
Test Items	Test Conditions	Failure Judgement Criteria	Defective(C)
T avaling	1 cycle -40°C(30min) to +150°C(30min)		n=22, C=0
Temperature cycling	20 cycles test	·	
Humidity (Steady State) +60°C,90%RH, 1000h			n=22, C=0
	1 cycle: -20°C (2h) to 70°C(2h)	$Vo < L \times 0.8$	
Damp Heat cyclic	Transfer time between high	Vo>U×1.2	n=22, C=0
	and low temp. is 1h 40 cycles test, 90%RH	$RegL>U\times1.2$	
High temp. storage	+150℃, 1000h	RegI $>$ U $\times$ 1.2	n=22, C=0
Low temp. storage	-40℃, 1000h	RR <l×0.8< td=""><td>n=22, C=0</td></l×0.8<>	n=22, C=0
Onemtion life	Ta=25°C, Pd=1.4W,	Vi-o>U×1.2	n=22, C=0
Operation life	Without radiaton plate,1000h		
Mechanical shock	$15$ km/s <sup>2</sup> , 0.5ms each 3 times/ $\pm$ X, $\pm$ Y, $\pm$ Z	·	n=11, C=0
Vibration (Variable frequency)	200m/s <sup>2</sup> , 100 to 2000 to 100Hz/4 min		n=11, C=0
Vibration (variable frequency)	each 4 times/ X, Y, Z direction	U: Upper specification limit	
Soldering heat	260°C, 10 s, Dip up to	L: Lower specification limit	n=11, C=0
Soldering ficat	1.5mm from resin portion *3	L. Lower specification mine	
	$\pm 250\mathrm{V}, 200\mathrm{pF}, 0\Omega$		
Electrostatic discharge	Between GND and each terminal/ each 3		n=11, C=0
	times		
Robustness of Termination Weight: 10N			n=11, C=0
(Tensile test)	30 s/ each terminal	Failure if it has breakdown and	
Robustness of Termination	Weight: 2.5N	loosened pin.	11.00
(Bending test)	0° ~90° ~0° ~-90° ~0°		n=11, C=0
	each terminal *2		
	245±2°C, 3 s Solder: Sn/3.0Ag/0.5Cu	Failure if solder shall not be adhere	n=11, C=0
Solderability	Use EC19S(TAMURA KAKEN Corporation	at the area of 95% or more A portion.	
	made flux) *3		<u> </u>

- \*1 Although color of terminals may change, this change of color is not included in criteria of failure judjemen.
- \*2 Terminal bending direction is shown below.
- \*3 Soldering area is shown below.







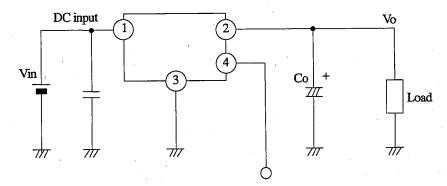
#### 5. Outgoing inspeciton

TABLE II-A single sampling plans for normal inspection based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection items	AQL(%)	Judgement criteria		
3.6.4	Electrical characteristics	0.1	It is based on the contents in the specification.		
Major defect	Marking	0.1	To be recognized.		
	Dimensions		It is based on the contents in the specification.		
Minor defect	Appearance	0.4	There should not have resin break off and lead bending.		

#### 6. Supplement

#### 6.1 Example of application

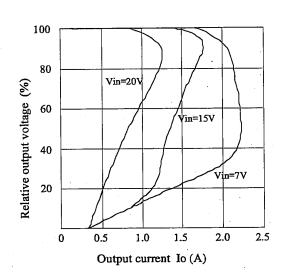


ON-OFF signal

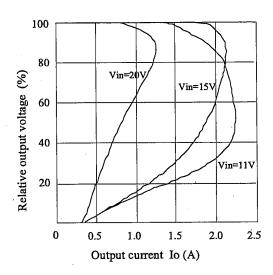
High or Open: Output ON : Output OFF

6.2 Overcurrent protection characteristics (Typical value)

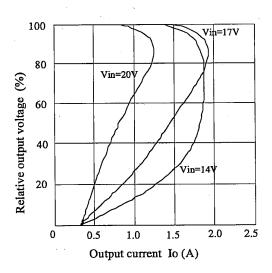
#### (1) PQ05RD1BJ00H



#### (2) PO09RD1BJ00H

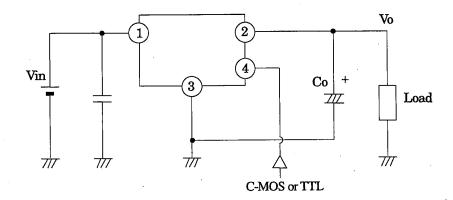


#### (3) PQ12RD1BJ00H

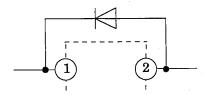


#### 7. Notes

#### 7.1 External connection



- (1) Please perform the shortest wiring for connection between Co and the individual terminal. There is case that oscillation occurs easily by kinds of capacitor capacity and how to wire. Before you use this device, you should confirm output voltage in your actual using conditions.
- The output ON/OFF control input terminal 4 is compatible with LS-TTL, and direct driving by TTL or C-MOS standard logic (RCA 4000 series) is also available. In case that ON/OFF terminal is not used, we recommend to pull up the ON/OFF terminal without resistance to input voltage.
- (3) As voltage application under conditions that the device pin is inserted divergently or reversely, may occur the degradation of characteristics or breakdown of the device, please avoid it absolutely.
- (4) In applying greater voltage to the output terminal ② than the voltage of the DC input terminal (1), breakdown of the device may occur. Especially in the case that the DC input terminal ① is short-circuited with GND, under the normal condition, the charge that is being charged into the output capacitor (Co) flows into the input side.



#### 7.2 Mounting

- (1) Please perform processing so that mechanical stress shall not be applied to the surface of the terminal and mold resin.
- (2) Please fix the device on the heat sink with tightening torque of 0.4 to 0.5N m by using M3 biss. At that time, please perform processing so that mechanical stress shall not be applied to the terminal and mold resin. It is recommended to use flat washer for tightening a screw. Strictly observe the following items to radiate the heat generated in the device inside effectively.
  - Warp and unevenness shall not occur on the contact surface of the heat sink and device.
  - Metal dust and burr shall not be attached to the contact surface of the heat sink and device.
  - (c) Uniformly apply silicon grease on the contact surface of the heat sink and device. Please select the grease having no secular alteration in the operating temperature range. And, grease to be used
    - No secular variation in operating temperature range.
    - ② Base oil does not separate and it does not stay in the device.
    - If base oil stay in the device, operation and life time are not given bad affection. For example, we recommend G-746; Shin-Etsu Chemical Co., Ltd. and SC-102; Toray Dow Coming Silicone Co., Ltd.



#### 7.3 Thermal protection design

Internal power dissipation (Pd) of device is obtained by the following equation.

 $Pd=Io\times(Vin-Vo)+Vin\times Iq$ 

If the maximum operating temperature and Pd when the element is operating are determined,

use such a heat sink as allows the element to operate within the safety operation area specified by the degrading curve in Fig. 1. Insufficient radiation or in case of using exceeding the limitation of the inemal power dissipation curve gives an unfavorable influence to the normal operation and reliability of the device.

In the case of no passage within the safety operational territory illustrated by the degrading curve, the overheat protection circuit operates to let output fall down, please avoid keeping such condition for a long time.

#### 7.4 Static electricity

Good caution must be exercised against static electricity since this device consists of a bipolar IC.

Following are some examples of preventive measures against excessive voltages such as caused by static electricity.

- (a) Human body must be grounded to discharge the static electricity from the body or cloth.
- (b) Anything that is in contact with the device such as workbench, inserter, or measuring instrument must be grounded.
- (c) Use a solder dip basin with a minimum leak current (isolation resistance  $10M\Omega$  or more) from the commercial power supply. Also the solder dip basin must be grounded.

#### 7.5 For cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power

output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that doesn't occur any defect before starting

the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

#### 7.6 Storage environment

The products shall be stored at the temperature 5 to 30°C and the humidity lower than 70%RH. Regarding the devices stored for long time, there is possibility that deterioration of lead pin color and solderability may occur. Please use the devices after checking the solderability in advance.